Silicon N-Channel MOS FET

# **HITACHI**

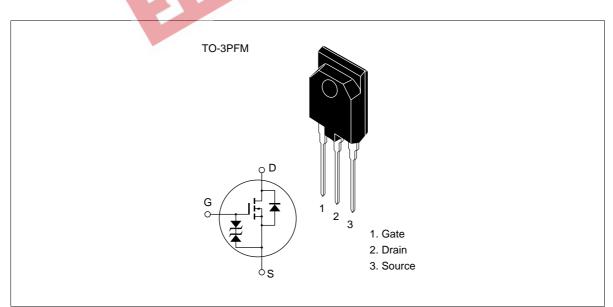
## Application

High speed power switching

## **Features**

- Low on-resistance
- High speed switching •
- Low drive current ٠
- Built-in fast recovery diode ( $t_{rr} = 90 \text{ ns}$ ) •
- ·com.cn Suitable for motor control, switching regulator and DC – DC converter •

## Outline





## **Absolute Maximum Ratings** ( $Ta = 25^{\circ}C$ )

Symbol	Ratings	Unit	
V <sub>DSS</sub>	250	V	
V <sub>GSS</sub>	±30	V	
I <sub>D</sub>	30	А	
I *1 D(pulse)	120	А	
I <sub>DR</sub>	30	А	
Pch*2	60	W	
Tch	150	°C	
Tstg	-55 to +150	°C	
	$V_{DSS}$ $V_{GSS}$ $I_D$ $I_{D(pulse)}^{*1}$ $I_{DR}$ $Pch^{*2}$ $Tch$	V         250           V $\pm 30$ I $D$	

Notes 1. PW  $\leq$  10  $\mu$ s, duty cycle  $\leq$  1%

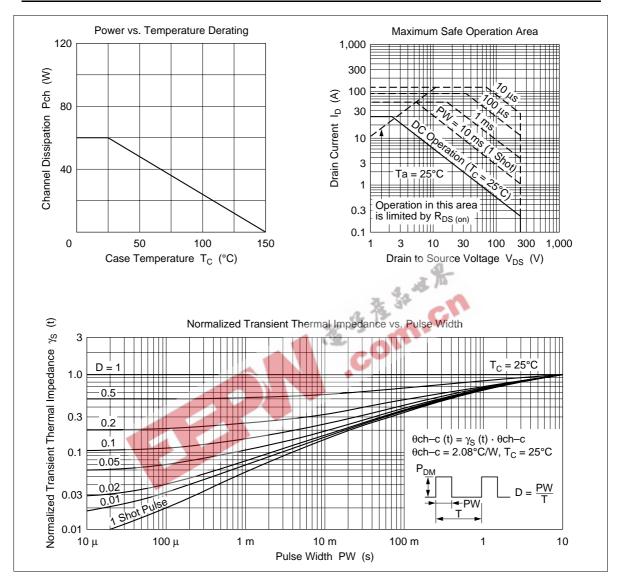
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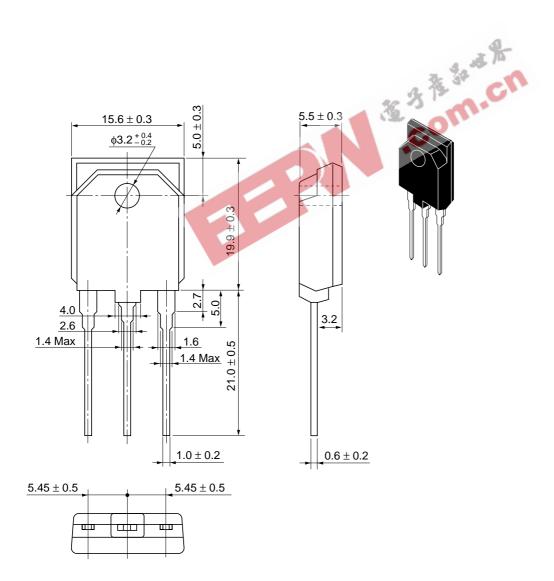
<sup>2.</sup> Value at  $T_c = 25^{\circ}C$ 

# **Electrical Characteristics** (Ta = $25^{\circ}$ C)

Item	Symbol	Min	Тур	Max	Unit	Test conditions
Drain to source breakdown voltage	$V_{\rm (BR)DSS}$	250	—	—	V	$I_{\rm D}$ = 10 mA, $V_{\rm GS}$ = 0
Gate to source breakdown voltage	$V_{\rm (BR)GSS}$	±30	_	—	V	$I_{g} = \pm 100 \ \mu A, \ V_{DS} = 0$
Gate to source leak current	I <sub>GSS</sub>	_	_	±10	μΑ	$V_{\rm GS} = \pm 25 \ V, \ V_{\rm DS} = 0$
Zero gate voltage drain current	I <sub>DSS</sub>	—	—	250	μΑ	$V_{\rm DS} = 200 \ V, \ V_{\rm GS} = 0$
Gate to source cutoff voltage	$V_{\text{GS(off)}}$	2.0	_	3.0	V	$I_{\rm D} = 1 \text{ mA}, V_{\rm DS} = 10 \text{ V}$
Static drain to source on state resistance	$R_{DS(on)}$	—	0.075	0.095	Ω	$I_{D} = 15 \text{ A}, \text{ V}_{GS} = 10 \text{ V}^{*1}$
Forward transfer admittance	y <sub>fs</sub>	12	20	_	S	$I_{\rm D} = 15 \text{ A}, \text{ V}_{\rm DS} = 10 \text{ V}^{*1}$
Input capacitance	Ciss	_	3100	_	pF	$V_{\rm DS} = 10 \text{ V}, \text{ V}_{\rm GS} = 0,$
Output capacitance	Coss	_	1330	- 3:	pF	f = 1 MHz
Reverse transfer capacitance	Crss	_	190	37	pF	
Turn-on delay time	t <sub>d(on)</sub>	-	45	-0	ns	$I_{\rm D} = 15 \text{ A}, \text{ V}_{\rm GS} = 10 \text{ V},$
Rise time	t,		170	6	ns	$R_{L} = 2 \Omega$
Turn-off delay time	t <sub>d(off)</sub>	11	270	_	ns	_
Fall time	t <sub>f</sub>	X.	150	—	ns	
Body to drain diode forward voltage	V <sub>DF</sub>	-	1.0	_	V	$I_{\rm F} = 30$ A, $V_{\rm GS} = 0$
Body to drain diode reverse recovery time	t <sub>rr</sub>	_	90	_	ns	$I_{F} = 30 \text{ A}, V_{GS} = 0,$ $di_{F}/dt = 100 \text{ A}/\mu\text{s}$

See characteristic curves of 2SK1669.





Hitachi Code	TO-3PFM
JEDEC	
EIAJ	_
Weight (reference value)	5.6 g

Unit: mm

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